

# 产品承认书 SPECIFICATION FOR APPROVAL

USTOMER 公司料号: XRIM322510SR47MBCA 公司品名: Miniaturized integrated inductor WR PART NAME								
UR PART NO.       XRIM322510SR47/MBCA         公司品名:       Miniaturized integrated inductor         WINDART NAME       数量: 0PCS         ATE SAMPLES	客户名称: CUSTOMER							
Miniaturized integrated inductor         詳日期:       数量: 0PCS         ATE SAMPLES      QUANTITY         制造确认 MANUFACTURER APPROVE         拟制 DRAWN       审核 CHECKED         山山 Jialing       Rao ping         Liu Jialing       Rao ping         上i Zhengxiong         空冷和状 CUSTOMER APPROVE         安户确认 CUSTOMER APPROVE         保力料号 CUSTOMER NAME:         大户料号 CUSTOMER P/N:         路型号 DESCRIPTION:       Size 322510 inductance: 0.47uH         拉音結果:       □ 合格 □不合格       签名及盖章:         NSPECT RESULT       ACCEPT       REJECT	我司料号: OUR PART NO.		XRIM322510SR47MBCA					
ATE SAMPLES	我司品名: OUR PART NAME	Mi	iniaturized integ	rated inducto	r			
救制 DRAWN     审核 CHECKED     确认 APPROVED       Liu Jialing     Rao ping     Li Zhengxiong       客户确认 CUSTOMER APPROVE       客户執号 CUSTOMER NAME:       第户科号 CUSTOMER P/N:       路型号 DESCRIPTION:     Size 322510 inductance: 0.47uH       空香結果:     □ 合格 □不合格     签名及盖章:       NSPECT RESULT     ACCEPT     REJECT	送样日期: DATE SAMPLES							
Liu Jialing     Rao ping     Li Zhengxiong       客户确认 CUSTOMER APPROVE       客户确认 CUSTOMER APPROVE       客户名称 CUSTOMER NAME:       字户名称 CUSTOMER P/N:       路型号 DESCRIPTION:     Size 322510 inductance: 0.47uH       查結果:     □ 合格 □不合格     签名及盖章:       NSPECT RESULT     ACCEPT     REJECT		制造确	认 MANUFACTU	<b>TRER APPROV</b>	VE			
客户确认 CUSTOMER APPROVE 客户名称 CUSTOMER NAME: 客户料号 CUSTOMER P/N: 恐格型号 DESCRIPTION: Size 322510 inductance: 0.47uH 改査結果: □合格 □不合格 签名及盖章: NSPECT RESULT ACCEPT REJECT SIGNATURE AND STAMP	拟制 DRA	WN	审核 CHEC	KED	确认 APPROVED			
第户名称 CUSTOMER NAME: 第户科号 CUSTOMER P/N: 副格型号 DESCRIPTION: Size 322510 inductance: 0.47uH 直査結果: □合格 □不合格 签名及盖章: NSPECT RESULT ACCEPT REJECT SIGNATURE AND STAMP	Liu Jial	Liu Jialing Rao pin			Li Zhengxiong			
AA型号 DESCRIPTION: Size 322510 inductance: 0.47uH A查結果: □ 合格 □不合格 签名及盖章: NSPECT RESULT ACCEPT REJECT SIGNATURE AND STAMP	客户名称 CUSTO			R APPROVE				
查結果: □ 合格 □不合格 签名及盖章: NSPECT RESULT ACCEPT REJECT SIGNATURE AND STAMP	客户料号 CUSTO	OMER P/N:						
NSPECT RESULT ACCEPT REJECT SIGNATURE AND STAMP	规格型号 DESCR	IPTION:	Size <b>322510</b>	inductance: 0	). 47uH			
	检查結果: 🗆	合格 口不合	格	签名及盖述	章:			
	INSPECT RESUI 说明 REMARK:	LT ACCEI	PT REJECT	SIGNATU	RE AND STAMP			

如对本承认书内容有异议请提出或标记发送至我司 ,本承认书在未收到异议回复时于本承认书提供-周后生效。

If you have any objection to the contents of this acknowledgement, please put forward or mark it and send it to our company. This acknowledgement will take effect one week after it is provided if you do not receive an objection reply.

东莞市祥如电子有限公司 Dongguan xiangru electronics co., ltd

Tel: 0769-86346548 Fax: 0769-86346358

Email: dgxiangru@126.com



### 1. <u>Scope</u>

## Featurs

- 11 Metal material for large current and low loss.
- 2 High performance (Isat) realized by metal dust core.
- B Low loss realized with low Rdc.
- 4 Closed magnetic circuit design reduces leakage flux.
- 5 Vinyl thermal spray, better surface compactness.
- 16 Environmental requirements must comply with the QESP-44 document
- 17 100% lead (Pb) free meet RoHS2.0 and Halogen, Reach and other legal and regulatory requirements standard.

## Application

- 2.1 DC/DC converters.
- 2.2 Pad,Smart phone.
- 2.3 Portable gaming devices, Smart wear, Wi-Fi module.
- 2.4 Notebooks, VR, AR.
- 2.5 LCD displays, HDDs, DVCs, DSCs, etc.
- 2.6 Baseband power supply, Amplifier, Power management, Module power supply, Camera power manageme.

### 2. Ordering Procedure

XRIM	3225	10	S	R47	Μ	В	С	Α
1	2	3	4	5	6	7	8	9

DSeries Name: Mini Molding Power Inductors

②External Dimensions(L×W):3225=3.2\*2.5 mm

③External Dimensions(H):10=1.0 mm

④Size Tolerance:S=±0.2mm

⑤Inductance value:R47=0.47uH

Tolerance:M=±20%

⑦Coating color:B=Black

Product type:C=Common

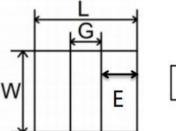
Special define:A=Routine

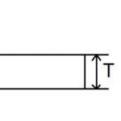
For special characteristics, please refer to the specific values in Item 5 "Specifications".

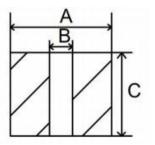


### 3. SHAPE AND DIMENSIONS

# **Outline Dimensions**







**Recommend Land Pattern Dimensions** 

### Units:mm

Series	L	G	W	Е	Т	А	В	С
XRIM322510S	$3.2 \pm 0.2$	$1.0 \pm 0.2$	$2.5 \pm 0.2$	$1.05 \pm 0.2$	1.00Max.	3.20	0.90	2.50

### 4. Marking

# No Marking

## 5. <u>Specifications</u>

P/N	L0(µH) @ (0A) 1MHz	Rdc(mΩ)		Heat rating current Irms(A)		Saturation current Isat(A)	
		Typical	Max	Typical	Max	Typical	Max
XRIM322510SR47MBCA	0.47	17	22	6.4	5.9	8.3	7.6

Test remarks

Note 1.: All test data is referenced to 25 °C ambient.

Note 2.: Test Condition:1MHz, 1.0Vrms.

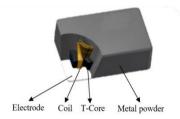
Note 3.: Irms:DC current (A) that will cause an approximate  $\Delta T$  of 40 °C.

Note 4.: Isat:DC current (A) that will cause L0 to drop approximately 30%.

Note 5.: Operating Temperature Range  $-55^{\circ}$ C to  $+ 125^{\circ}$ C.

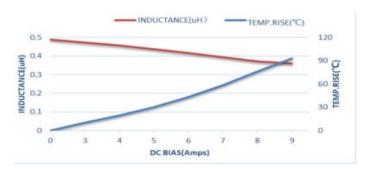
- Note 6.: The part temperature (ambient + temp rise) should not exceed 125 under °C the worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the endapplication.
- Note 7.: The rated current as listed is either the saturation current or the heating current depending on which value is lower.

## 6. <u>Structure</u>



7. Current Characteristic

## XRIM322510SR47MBCA





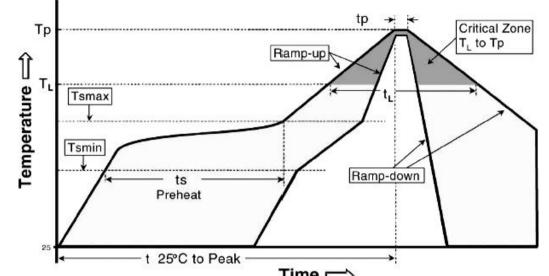
## 8. <u>Reliability</u>

Item	Requirements	Test Methods and Remarks
Insulation Resistance	≥100MΩ	100 VDC between inductor coil and The middle of the top surface of the body for 60 seconds.
Solderability	90% or more of electrode area shall be coated by new solde.	Dip pads in flux . Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free). Solder Temperature: $245 \pm 5^{\circ}$ C. Immersion Time: $(5 \pm 1)$ s.
Resistance to Soldering Heat	No visible mechanical damage. Inductance change: Within ±10%.	Dip pads in flux. Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free). Solder Temperature: 260±5°C. Immersion Time: 10±1sec.
Adhesion of teral electrode	Strong bond between the pad and the core, without come off PCB.	Inductors shall be subjected to $(260\pm5)^{\circ}$ C for $(20\pm5)$ s Soldering in the base whit 0.3mm solder. And then aplombelectrode way plus tax 12 N for (10±1) seconds.
High temperature	No case deformation or change in appearance. Inductance change: Within ±10%	Temperature: 125±2°C. Time : 1000 hours. Measurement at 24±4 hours after test conclusion.
Low temperature	No visible mechanical damage. Inductance change: Within ±10%	Temperature: -55±2°C. Time : 1000 hours. Measurement at 24±4 hours after test conclusion.
Thermal shock	No visible mechanical damage. Inductance change: Within ±10%	The test sample shall be placed at (-55±3)°C and (125±3)°C for (30±3), different temperature conversion time is 2~3 utes. The temperature cycle shall be repeated 32 cycles. Placed at room temperature for 2 hours, within 48±4 hours of testing.
Temperature characteristic	Inductance change Pc-b,Pc-d: Within ±10%	a: +20 °C (30~45) → b: -40 °C (30~45) → c: +20 °C (30~45) → d: +125 °C (30~45) → e: +20 °C (30~45) → e: +20 °C (30~45) $P_{c-b} = \frac{L_b - L_c}{L_c} \times 100\%$ $P_{c-d} = \frac{L_d - L_c}{L_c} \times 100\%$
Static Humidity	No visible mechanical damage. Inductance change: Within ±10%	Inductors shall be subjected to $(95\pm3)$ %RH . at $(60\pm2)$ °C for $(1000\pm4)$ h. Placed at room temperature for 2 hours, within 48 hours of testing.
Life	No visible mechanical damage. Inductance change: Within ±10%	Inductors shall be store at (85±2)°C for (1000±4) hours with Irms applied. Placed at room temperature for 2 hours, within 48 hours of testing



## 9. Soldering Condition

(This is for recommendation, please customer perform adjustment according to actual application) Recommend Reflow Soldering Profile : (solder : Sn96.5 / Ag3 / Cu0.5)



Lead (Pb)-Free solder
150℃
200°C
60 -120 seconds
3°C / second max.
217°C
60-150 seconds
260°C
10 seconds
6°C/second max.
8minutes max.

Allowed Re-flow times : 2 times

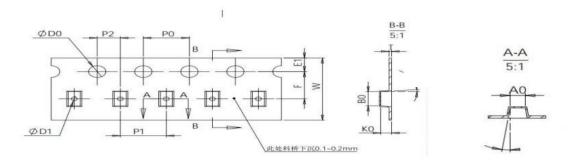
Remark : To avoid discoloration phenomena of chip on terminal electrodes, please use N2 Re-flow furnace .



## 10. Packing

101 Dimension of plastic taping: (Unit: mm)

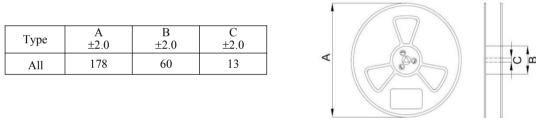
The following dimensions are related to the actual fit of the machine, for reference only.



Series	W	A0	BO	D0	D1	E
tolerance	/	/	/	+0.1/-0	±0.20	±0.10
322510	8.0±0.10	2.80+0.10/-0.05	3. 50+0. 10/-0. 05	1.5	1.0	1.75

Series	F	К0	PO	P2	P1	Т	package
tolerance	±0.10	/	±0.10	±0.10	±0.10	±0.05	quantity
322510	3.5	$1.15 \pm 0.10$	4.0	2.0	4.0	0.25	ЗК

## 102 Dimension of Reel : (Unit: mm)



## 11. <u>Note</u>

1B

- recommend products store in warehouse with temperature between 15 to 35°C under humidity between 25 to 75%RH.
   Even under storage conditions recommended above, solder ability of products will be degraded stored over 1 yearold.
- 12 Cartons must be placed in correct direction which indicated on carton, otherwise the reel or wire will be deformed.
  - Storage conditions as below are inappropriate:
    - a. Stored in high electrostatic environment
    - b. Stored in direct sunshine, rain, snow or condensation.
    - c. Exposed to sea wind or corrosive gases, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, NO<sub>2</sub>, etc.
- 14 The products are used in circuit board thickness greater than 1.6mm. If customers use less than the thickness of the circuit board that you should confirm with the company, in order to recommend a more suitable product.

## 12. <u>Record</u>

Version	Description	Page	Date	Amended by	Checked by
A0	First version	1~5	Nov.6.2023	Xirui.Niu	Congdian.Lu